CLAIMS

- a resimmixture of (A) from 1 to 99 by weight of a polycarbonate and (P) from 1 to 99 by weight of a thermoplastic polyester, and contains, relative to 100 parts by weight of the resimmixture, (C) from 0.01 to 3 parts by weight of a polyfluoro-olefin resim, and (D) from 1 to 400 parts by weight of a polyfluoro-olefin resim, and (D) from 1 to 400 parts by weight of a polycarbonate-polyorganosiloxane copolymer and/or (E) from 0.1 to 10 parts by weight of a functional silicone compound, and of which the silicone content derived from the component (D) and/or the component (E) falls between 0.5 and 10 by weight of the composition.
- 2. The polycarbonate resin composition as claimed in claim 1, which further contains (F) from 1 to 50 parts by weight of an inorganic filler.

3. The polycarbonate resin composition as claimed in claim 1 or 2, wherein the functional silicone compound for the component (E) has a basic structure of a general formula (1):

$$\mathbf{R}^{1}_{i}\mathbf{R}_{i}\mathbf{S}\mathbf{i}\boldsymbol{\Theta}_{i}\mathbf{A}_{i}\mathbf{N}_{i}$$

wherein R indicases a functional group, F indicates a hydrocarbon residue having from 1 to 12 carbon atoms, and a and b are numbers satisfying the relations of -< a \leq 3, 0 \leq b < 3, and 0 < a + b \leq 3.

4. The polycarbonate resimposmposition as claimed in

functional silicone compound for the component (F) is selected from an alkoxy group, a vinyl group, a hydroge residue and an epoxy group.

- 5. The polycarbonate resin composition as claimed in any of claims I to 4, wherein the functional group in the functional silicone compound for the component (E) is a methoxy group or a viryl group.
- 6. The polycarbonate resin composition as claimed in any of claims 1 to 5, wherein the polyfluoro-olefin resin for the component (C) is a fibril-forming polytetrafluoroethylene having a mean molecular weight of at least 500,000.
- 7. The polycarbonate resin composition as claimed in any of claims I to 6, wherein the polycarbonate for the component (A) has a viscosity-average molecular weight of from 15,000 to 20,000.
- 8. The polycarbonate resin composition as claimed in any of claims 2 to 7, wherein the inorganic filler for the component (F) is talk having a mean particle size of from 0.2 to 20 μm .
- 9. Housings or parts of electric and electronic appliances, which comprise the polycarbonate resin composition of any of claims 1 to 6.

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